

WHAT IS CLAIMED IS:

1                   1.     A method for filtering signals to obtain a desired passband of  
2 frequencies, the method comprising:  
3                   providing a micromechanical filter apparatus including a  
4 micromechanical resonator having a fundamental resonant mode formed on a  
5 substrate and a support structure anchored to the substrate to support the resonator  
6 above the substrate; and  
7                   vibrating the resonator so that the apparatus passes a desired  
8 frequency range of signals while substantially attenuating signals outside the desired  
9 frequency range, wherein the support structure is attached to the resonator so that  
10 the resonator is isolated from the support structure during resonator vibration.

1                   2.     The method as claimed in claim 1 wherein the step of  
2 vibrating includes forcing different portions of the resonator to move in opposite  
3 directions at the same time so that the resonator vibrates in a resonant mode,  $m$ ,  
4 higher than the fundamental resonant mode wherein the resonator has  $m + 1$  nodal  
5 points.

1                   3.     The method as claimed in claim 2 wherein the  
2 micromechanical filter apparatus includes a plurality of input electrodes spaced  
3 along the resonator to allow electrostatic excitation of the resonator and wherein the  
4 step of forcing includes the steps of applying an in-phase signal to one of the input  
5 electrodes to deflect a first portion of the resonator in a first direction and applying  
6 an out-of-phase signal to another input electrode to deflect a second portion of the  
7 resonator in a second direction opposite the first direction to force the resonator into  
8 a correct mode shape.

1                   4.     The method as claimed in claim 2 wherein the  
2 micromechanical filter apparatus includes an input electrode formed on the substrate  
3 to allow electrostatic excitation of the resonator and wherein the step of forcing  
4 includes the step of applying a signal to the input electrode, the resonator and the

5 input electrode defines a capacitive transducer gap therebetween and wherein the  
6 micromechanical resonator further includes  $m+1$  spacers having a height and which  
7 extend between the resonator and the substrate at the  $m+1$  nodal points and wherein  
8 the  $m+1$  spacers force the resonator into a correct mode shape during the  
9 application of the signal to the input electrode.

1 5. A micromechanical filter apparatus for filtering signals to  
2 obtain a desired passband of frequencies, the apparatus comprising:  
3 a substrate;  
4 a plurality of intercoupled micromechanical elements including a  
5 resonator; and  
6 a support structure anchored to the substrate to support the elements  
7 above the substrate wherein the support structure and the resonator are both  
8 dimensioned so that the resonator is isolated from the support structure during  
9 resonator vibration wherein energy losses to the substrate are substantially  
10 eliminated and wherein the apparatus is a high-Q apparatus.

1 6. The apparatus as claimed in claim 5 wherein the support  
2 structure is attached to the resonator at at least one nodal point of the resonator.

1 7. The apparatus as claimed in claim 5 wherein the signals are  
2 RF signals.

1 8. The apparatus as claimed in claim 7 wherein the apparatus is  
2 an RF filter apparatus.

1 9. The apparatus as claimed in claim 5 wherein the apparatus is  
2 a bandpass filter apparatus.

1 10. The apparatus as claimed in claim 5 wherein the support  
2 structure includes at least one beam attached to a nodal point of the resonator.

1                   11.     The apparatus as claimed in claim 5 further comprising at least  
2     one input electrode formed on the substrate to allow electrostatic excitation of the  
3     resonator wherein the resonator and the at least one input electrode define a  
4     capacitive transducer gap therebetween.

1                   12.     The apparatus as claimed in claim 11 further comprising at  
2     least one spacer having a height, each spacer extending between the resonator and  
3     the substrate at a nodal point of the resonator wherein the size of the gap is based  
4     on the height of the at least one spacer during pull down of the resonator.

1                   13.     The apparatus as claimed in claim 5 wherein the apparatus is  
2     a silicon-based filter apparatus.

1                   14.     The apparatus as claimed in claim 5 wherein the apparatus is  
2     a diamond-based filter apparatus.

1                   15.     The apparatus as claimed in claim 11 further comprising at  
2     least one output electrode formed on the substrate to sense output of the apparatus.

1                   16.     The apparatus as claimed in claim 5 wherein the support  
2     structure includes a plurality of beams and the resonator includes a plurality of nodal  
3     points and wherein each of the beams is attached to the resonator at one of the nodal  
4     points of the resonator so that the resonator sees substantially no resistance to  
5     transverse or torsional motion from the support structure.

1                   17.     The apparatus as claimed in claim 11 wherein a pair of  
2     balanced input electrodes are formed on the substrate to allow electrostatic excitation  
3     of the resonator.

1                   18.     The apparatus as claimed in claim 15 wherein a pair of  
2     balanced output electrodes are formed on the substrate to sense output of the  
3     apparatus.

1                    19.    The apparatus as claimed in claim 5 wherein the plurality of  
2    intercoupled micromechanical elements includes a pair of intercoupled end  
3    resonators.

1                    20.    The apparatus as claimed in claim 19 wherein the support  
2    structure supports the end resonators above the substrate.

1                    21.    The apparatus as claimed in claim 19 wherein the plurality of  
2    intercoupled micromechanical elements further includes an inner resonator  
3    intercoupled to the end resonators.

1                    22.    The apparatus as claimed in claim 21 wherein the support  
2    structure supports the end and inner resonators above the substrate.

1                    23.    The apparatus as claimed in claim 21 wherein the plurality of  
2    intercoupled micromechanical elements further include a plurality of coupling links  
3    for coupling the inner resonator to the end resonators.

1                    24.    The apparatus as claimed in claim 23 wherein the coupling  
2    links are operable in multiple modes.

1                    25.    The apparatus as claimed in claim 23 wherein the coupling  
2    links are higher mode coupling beams.